

Single Inverter with Schmitt-Trigger Input

MC74HC1G14

The MC74HC1G14 is a high speed CMOS inverter with Schmitt-Trigger input fabricated with silicon gate CMOS technology.

The internal circuit is composed of multiple stages, including a buffer output which provides high noise immunity and stable output.

The MC74HC1G14 output drive current is 1/2 compared to MC74HC series.

Features

- High Speed: $t_{PD} = 7 \text{ ns}$ (Typ) at $V_{CC} = 5 \text{ V}$
- Low Power Dissipation: $I_{CC} = 1 \mu\text{A}$ (Max) at $T_A = 25^\circ\text{C}$
- High Noise Immunity
- Balanced Propagation Delays ($t_{PLH} = t_{PHL}$)
- Symmetrical Output Impedance ($I_{OH} = I_{OL} = 2 \text{ mA}$)
- Chip Complexity: < 100 FETs
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

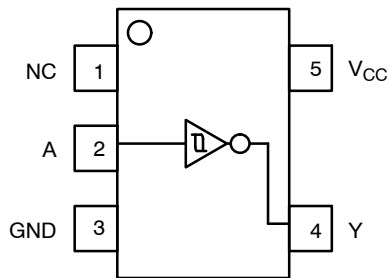


Figure 1. Pinout

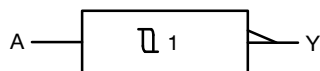


Figure 2. Logic Symbol

PIN ASSIGNMENT	
1	N/C
2	A
3	GND
4	Y
5	V_{CC}

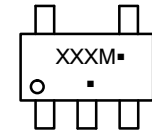
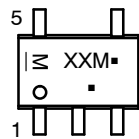


SC-88A
DF SUFFIX
CASE 419A



SC-74A
DBV SUFFIX
CASE 318BQ

MARKING DIAGRAMS



XXX = Specific Device Code

M = Date Code

▪ = Pb-Free Package

(Note: Microdot may be in either location)

FUNCTION TABLE

Input	Output
A	Y
L	H
H	L

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

MC74HC1G14

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage	−0.5 to +6.5	V
V _{IN}	DC Input Voltage	−0.5 to V _{CC} +0.5	V
V _{OUT}	DC Output Voltage	−0.5 to V _{CC} +0.5	V
I _{IK}	DC Input Diode Current	±20	mA
I _{OK}	DC Output Diode Current	±20	mA
I _{OUT}	DC Output Source/Sink Current	±12.5	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Ground Pin	±25	mA
T _{STG}	Storage Temperature Range	−65 to +150	°C
T _L	Lead Temperature, 1 mm from Case for 10 Seconds	260	°C
T _J	Junction Temperature Under Bias	+150	°C
θ _{JA}	Thermal Resistance (Note 1)	SC-88A SC-74A 377 320	°C/W
P _D	Power Dissipation in Still Air	SC-88A SC-74A 332 390	mW
MSL	Moisture Sensitivity	Level 1	
F _R	Flammability Rating	Oxygen Index: 28 to 34 UL 94 V-0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage (Note 2)	Human Body Model Charged Device Model 2000 1000	V
I _{LATCHUP}	Latchup Performance (Note 3)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 20 ounce copper trace with no air flow per JESD51-7.
2. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued per JEDEC/JEP172A.
3. Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage	2.0	6.0	V
V _{IN}	DC Input Voltage	0.0	V _{CC}	V
V _{OUT}	DC Output Voltage	0.0	V _{CC}	V
T _A	Operating Temperature Range	−55	+125	°C
t _r , t _f	Input Rise and Fall Time			
	V _{CC} = 2.0 V	−	No Limit	ns/V
	V _{CC} = 2.3 V to 2.7 V	−	No Limit	
	V _{CC} = 3.0 V to 3.6 V	−	No Limit	
	V _{CC} = 4.5 V to 6.0 V	−	No Limit	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.



MC74HC1G14

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	V _{CC} (V)	T _A = 25 °C			-40 °C ≤ T _A ≤ 85 °C		-55 °C ≤ T _A ≤ 125 °C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
V _{T+}	Positive Threshold Voltage		3.0	–	2.0	2.2	–	2.2	–	2.2	V
			4.5	–	3.0	3.15	–	3.15	–	3.15	
			5.5	–	3.6	3.85	–	3.85	–	3.85	
V _{T–}	Negative Threshold Voltage		3.0	0.9	1.5	–	0.9	–	0.9	–	V
			4.5	1.35	2.3	–	1.35	–	1.35	–	
			5.5	1.65	2.9	–	1.65	–	1.65	–	
V _H	Hysteresis Voltage		3.0	0.30	0.57	1.20	0.30	1.20	0.30	1.20	V
			4.5	0.40	0.67	1.40	0.40	1.40	0.40	1.40	
			5.5	0.50	0.74	1.60	0.50	1.60	0.50	1.60	
V _{OH}	High-Level Output Voltage	V _{IN} = V _{IH} or V _{IL} I _{OH} = –20 μA	2.0	1.9	2.0	–	1.9	–	1.9	–	V
			3.0	2.9	3.0	–	2.9	–	2.9	–	
			4.5	4.4	4.5	–	4.4	–	4.4	–	
			6.0	5.9	6.0	–	5.9	–	5.9	–	
		V _{IN} = V _{IH} or V _{IL} I _{OH} = –2 mA I _{OH} = –2.6 mA	4.5	4.18	4.31	–	4.13	–	4.08	–	
			6.0	5.68	5.80	–	5.63	–	5.58	–	
V _{OL}	Low-Level Output Voltage	V _{IN} = V _{IH} or V _{IL} I _{OL} = 20 μA	2.0	–	0.0	0.1	–	0.1	–	0.1	V
			3.0	–	0.0	0.1	–	0.1	–	0.1	
			4.5	–	0.0	0.1	–	0.1	–	0.1	
			6.0	–	0.0	0.1	–	0.1	–	0.1	
		V _{IN} = V _{IH} or V _{IL} I _{OL} = 2 mA I _{OL} = 2.6 mA	4.5	–	0.17	0.26	–	0.33	–	0.40	
			6.0	–	0.18	0.26	–	0.33	–	0.40	
I _{IN}	Input Leakage Current	V _{IN} = 6.0 V or GND	6.0	–	–	±0.1	–	±1.0	–	±1.0	μA
I _{CC}	Quiescent Supply Current	V _{IN} = V _{CC} or GND	6.0	–	–	1.0	–	10	–	40	μA

AC ELECTRICAL CHARACTERISTICS

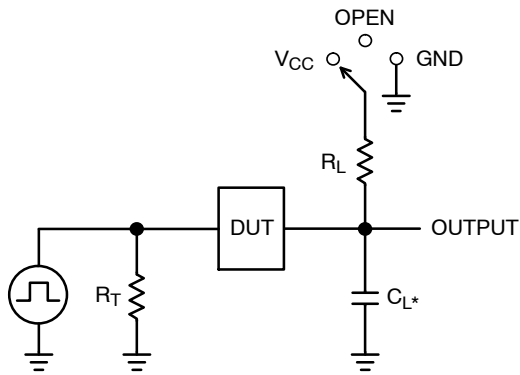
Symbol	Parameter	Test Conditions	T _A = 25 °C			-40 °C ≤ T _A ≤ 85 °C		-55 °C ≤ T _A ≤ 125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t _{PLH} , t _{PHL}	Propagation Delay, Input A or B to Y	V _{CC} = 5.0 V C _L = 15 pF	–	3.5	15	–	20	–	25	ns
		V _{CC} = 2.0 V C _L = 50 pF	–	19	100	–	125	–	155	
		V _{CC} = 3.0 V	–	10.5	27	–	35	–	90	
		V _{CC} = 4.5 V	–	7.5	20	–	25	–	35	
		V _{CC} = 6.0 V	–	6.5	17	–	21	–	26	
t _{TLH} , t _{THL}	Output Transition Time	V _{CC} = 5.0 V C _L = 15 pF	–	3	10	–	15	–	20	ns
		V _{CC} = 2.0 V C _L = 50 pF	–	25	125	–	155	–	200	
		V _{CC} = 3.0 V	–	16	35	–	45	–	60	
		V _{CC} = 4.5 V	–	11	25	–	31	–	38	
		V _{CC} = 6.0 V	–	9	21	–	26	–	32	
C _{IN}	Input Capacitance		–	5	10	–	10	–	10	pF

C _{PD}	Power Dissipation Capacitance (Note 4)	Typical @ 25 °C, V _{CC} = 5.0 V	pF
		10	

4. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no-load dynamic power consumption; P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.



MC74HC1G14



* C_L includes probe and jig capacitance
 R_T is Z_{OUT} of pulse generator (typically 50 Ω)
 $f = 1$ MHz

Figure 3. Test Circuit

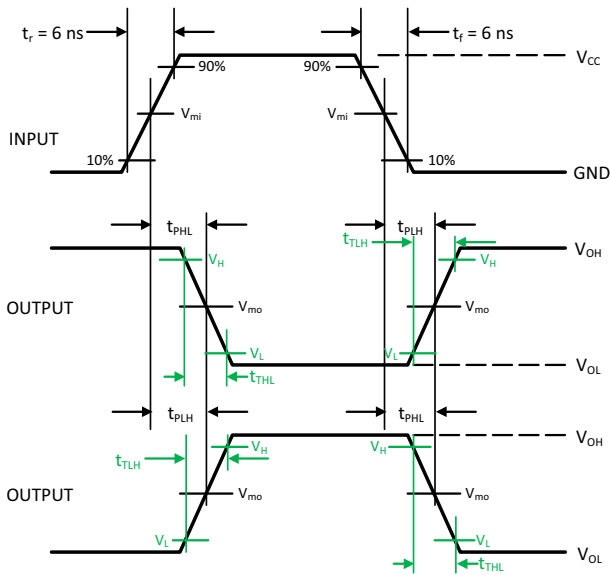


Figure 4. Switching Waveforms

Test	Switch Position	C_L , pF	R_L , Ω
t_{PLH} / t_{PHL}	Open	See AC Characteristics Table	X
t_{TLH} / t_{THL} (Note 5)	Open		X
t_{PLZ} / t_{PZL}	V_{CC}		1 k
t_{PHZ} / t_{PZH}	GND		1 k

X - Don't Care

V_{CC} , V	V_{mi} , V	V_{m0} , V		V_L , V	V_H , V	V_Y , V
		t_{PLH}, t_{PHL}	$t_{PZL}, t_{PLZ}, t_{PZH}, t_{PHZ}$			
3.0 to 3.6	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{OL} + 0.1 (V_{OH} - V_{OL})$	$V_{OL} + 0.9 (V_{OH} - V_{OL})$	0.3
4.5 to 5.5	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{OL} + 0.1 (V_{OH} - V_{OL})$	$V_{OL} + 0.9 (V_{OH} - V_{OL})$	0.3

5. t_{TLH} and t_{THL} are measured from 10% to 90% of $(V_{OH} - V_{OL})$, and 90% to 10% of $(V_{OH} - V_{OL})$, respectively.

MC74HC1G14

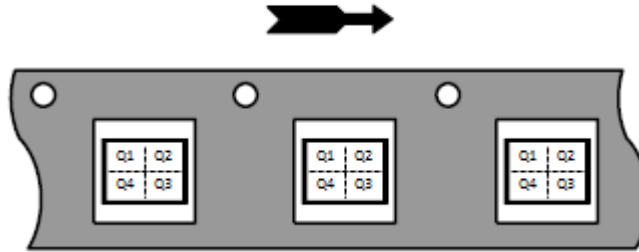
ORDERING INFORMATION

Device	Packages	Specific Device Code	Pin 1 Orientation (See below)	Shipping [†]
MC74HC1G14DFT1G	SC-88A	HA	Q2	3000 / Tape & Reel
MC74HC1G14DFT2G	SC-88A	HA	Q4	3000 / Tape & Reel
MC74HC1G14DBVT1G	SC-74A	HA	Q4	3000 / Tape & Reel

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

Pin 1 Orientation in Tape and Reel

Direction of Feed

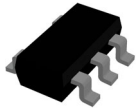


REVISION HISTORY

Revision	Description of Changes	Date
20	Revision to remove four "-Q" OPNs from ordering information table.	1/13/2026

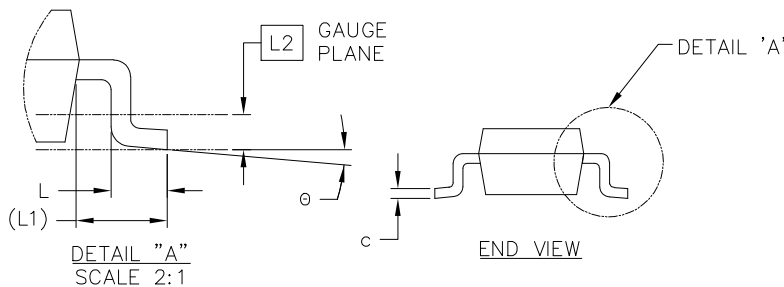
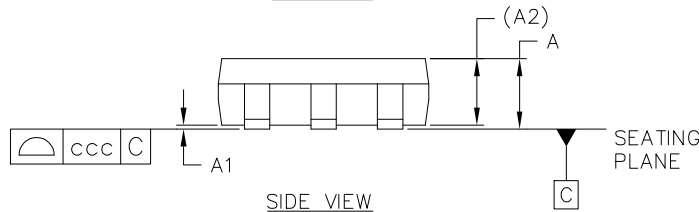
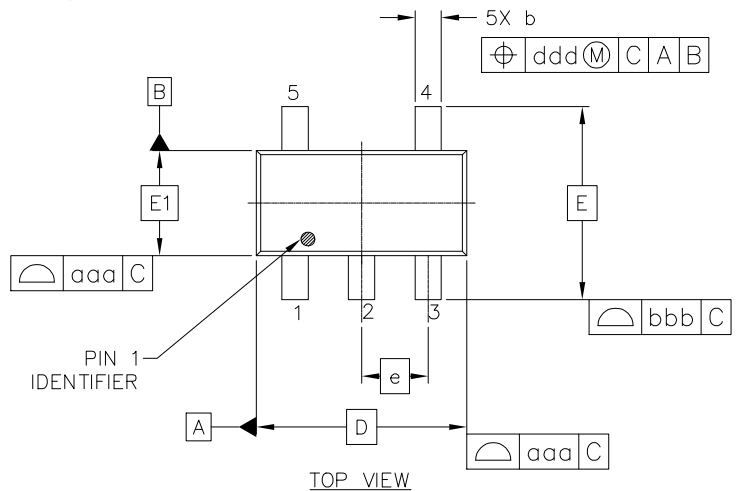
* Please note that this document has been previously updated prior to the inclusion of this revision history table and that the changes tracked only reflect what has occurred on the noted approval dates.



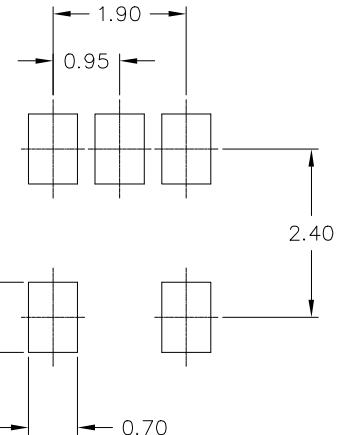


SC-74A-5 3.00x1.50x0.95, 0.95P
CASE 318BQ
ISSUE D

DATE 13 APR 2026



MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.90	1.00	1.10
A1	0.01	0.05	0.10
A2	0.95 REF		
b	0.25	0.37	0.50
c	0.10	0.18	0.26
D	3.00 BSC		
E	2.75 BSC		
E1	1.50 BSC		
e	0.95 BSC		
L	0.20	0.40	0.60
L1	0.60 REF		
L2	0.25 BSC		
θ	0°	5°	10°
TOLERANCE FORM AND POSITION			
aaa	0.15		
bbb	0.15		
ccc	0.05		
ddd	0.20		



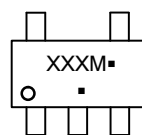
RECOMMENDED MOUNTING FOOTPRINT

*For additional information in our Pb-Free Strategy and Soldering details, Please download the onsemi Soldering and Mounting Techniques Reference manual. SOLDERRM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15mm PER SIDE.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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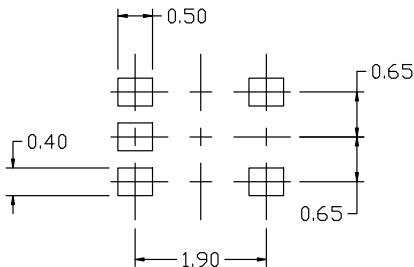
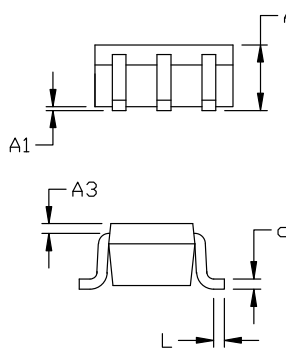
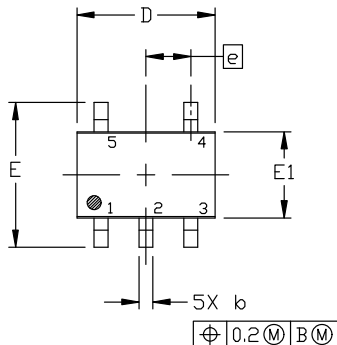
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SCALE 2:1

SC-88A (SC-70-5/SOT-353)
CASE 419A-02
ISSUE M

DATE 11 APR 2023

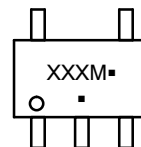

**RECOMMENDED
MOUNTING FOOTPRINT**

* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.80	0.95	1.10
A1	---	---	0.10
A3	0.20 REF		
b	0.10	0.20	0.30
c	0.10	---	0.25
D	1.80	2.00	2.20
E	2.00	2.10	2.20
E1	1.15	1.25	1.35
e	0.65 BSC		
L	0.10	0.15	0.30

**GENERIC MARKING
DIAGRAM***


*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

M = Date Code

▪ = Pb-Free Package

(Note: Microdot may be in either location)

STYLE 1:

- PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 2:

- PIN 1. ANODE
2. EMITTER
3. BASE
4. COLLECTOR
5. CATHODE

STYLE 3:

- PIN 1. ANODE 1
2. N/C
3. ANODE 2
4. CATHODE 2
5. CATHODE 1

STYLE 4:

- PIN 1. SOURCE 1
2. DRAIN 1/2
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 5:

- PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

STYLE 6:

- PIN 1. EMITTER 2
2. BASE 2
3. EMITTER 1
4. COLLECTOR
5. COLLECTOR 2/BASE 1

STYLE 7:

- PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 8:

- PIN 1. CATHODE
2. COLLECTOR
3. N/C
4. BASE
5. EMITTER

STYLE 9:

- PIN 1. ANODE
2. CATHODE
3. ANODE
4. ANODE
5. ANODE

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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